



PCB Number: PMP20654
PCB Rev: A

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Orderable: ChangeMe!		Designed for: Public Release	Mod. Date: 1/18/2017
TID #: N/A		Project Title: UCC28880 High side Buck	
Number: PMP20654	Rev: A	Sheet Title:	
SVN Rev: Version control disabled		Assembly Variant: 001	Sheet: 1 of 1
Drawn By:		File: PMP20654_BlankSheet.SchDoc	Size: B
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